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Fairchild Semiconductor FDC6331L

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FDC6331L

Integrated Load Switch

General Description

This device is particularly suited for compact power management in portable electronic equipment where 2.5V to 8V input and 2.8A output current capability are needed. This load switch integrates a small N-Channel power MOSFET (Q1) that drives a large PChannel power MOSFET (Q2) in one tiny SuperSOTTI package.

Applications

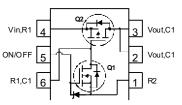
- · Load switch
- Power management

Features

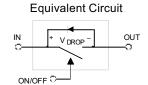
- -2.8 A, -8 V. $R_{DS(ON)}$ = 55 m Ω @ V_{GS} = -4.5 V $R_{DS(ON)}$ = 70 m Ω @ V_{GS} = -2.5 V $R_{DS(ON)}$ = 100 m Ω @ V_{GS} = -1.8 V
- Control MOSFET (Q1) includes Zener protection for ESD ruggedness (>6KV Human body model)
- High performance trench technology for extremely low R_{DS(ON)}











Absolute Maximum Ratings T_A=25°C unless otherwise noted

| Symbol | Parameter | | Ratings | Units | |
|-----------------------------------|--|----------|-------------|-------|--|
| V _{IN} | Maximum Input Voltage | | ± 8 | V | |
| V _{ON/OFF} | High level ON/OFF voltage range | | -0.5 to 8 | V | |
| Load | Load Current - Continuous | (Note 1) | 2.8 | A | |
| | - Pulsed | | 9 | | |
| P _D | Maximum Power Dissipation | (Note 1) | 0.7 | W | |
| T _J , T _{STG} | Operating and Storage Junction Temperature Range | | -55 to +150 | °C | |

Thermal Characteristics

| R _{0JA} | Thermal Resistance, Junction-to-Ambient | (Note 1) | 180 | °C/W |
|------------------|---|----------|-----|------|
| Rejc | Thermal Resistance, Junction-to-Case | (Note 1) | 60 | °C/W |

Package Marking and Ordering Information

| Device Marking | Device | Reel Size | Tape width | Quantity |
|----------------|----------|-----------|------------|------------|
| .331 | FDC6331L | 7" | 8mm | 3000 units |

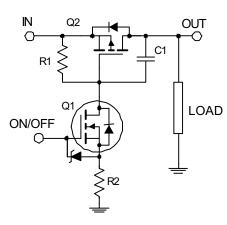


| Symbol | Parameter | Test Conditions | Min | Тур | Max | Units |
|--------------------------|---|---|-----|----------------|-----------------|-------|
| Off Char | acteristics | • | | | | • |
| BV _{IN} | Vin Breakdown Voltage | $V_{ON/OFF} = 0 \text{ V}, I_D = -250 \mu\text{A}$ | 8 | | | V |
| Load | Zero Gate Voltage Drain Current | V _{IN} = 6.4 V, V _{ON/OFF} = 0 V | | | -1 | μΑ |
| I _{FL} | Leakage Current, Forward | V _{ON/OFF} = 0 V, V _{IN} = 8 V | | | -100 | nA |
| I _{RL} | Leakage Current, Reverse | V _{ON/OFF} = 0 V, V _{IN} = -8 V | | | 100 | nA |
| On Char | acteristics (Note 2) | | | | | |
| V _{ON/OFF (th)} | Gate Threshold Voltage | $V_{IN} = V_{ON/OFF}$, $I_D = -250 \mu A$ | 0.4 | 0.9 | 1.5 | V |
| R _{DS(on)} | Static Drain–Source On–Resistance (Q2) | $V_{GS} = -4.5 \text{ V}, \qquad I_D = -2.8 \text{A}$ $V_{GS} = -2.5 \text{ V}, \qquad I_D = -2.5 \text{ A}$ $V_{GS} = -1.8 \text{ V}, \qquad I_D = -2.0 \text{ A}$ | | 34 45 64 | 55 70 100 | mΩ |
| R _{DS(on)} | Static Drain–Source On–Resistance (Q1) | $V_{GS} = 4.5 \text{ V}, \qquad I_D = 0.4 \text{A}$ $V_{GS} = 2.7 \text{ V}, \qquad I_D = 0.2 \text{ A}$ | | 3.1 3.8 | 4 5 | Ω |

Drain-Source Diode Characteristics and Maximum Ratings

| Is | Maximum Continuous Drain-Source Diode Forward Current | | | -0.6 | A |
|-----------------|---|---|---|------|---|
| V _{SD} | Drain–Source Diode Forward | $V_{ON/OFF} = 0 \text{ V}, I_S = -0.6 \text{ A} \text{ (Note 2)}$ | | -1.2 | V |
| | Voltage | | 1 | | i |

FDC6331L Load Switch Application Circuit



External Component Recommendation:

For additional in-rush current control, R2 and C1 can be added. For more information, see application note AN1030.

Notes: 1. $R_{\theta JA}$ is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. $R_{\theta JC}$ is guar anteed by design while $R_{\theta JA}$ is determined by the user's board design.

^{2.} Pulse Test: Pulse Width < 300 μ s, Duty Cycle < 2.0%.



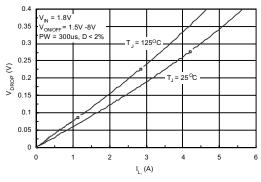


Figure 1. Conduction Voltage Drop Variation with Load Current.

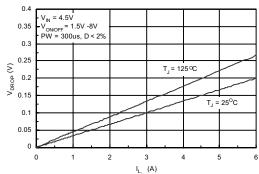


Figure 3. Conduction Voltage Drop Variation with Load Current.

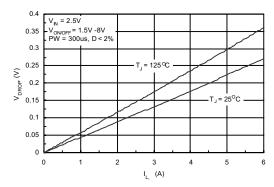


Figure 2. Conduction Voltage Drop Variation with Load Current.

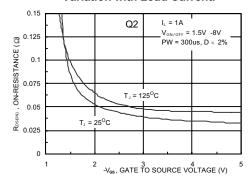


Figure 4. On-Resistance Variation With Input Voltage

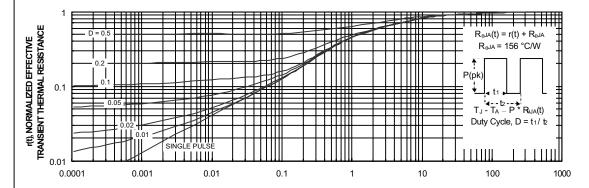


Figure 5. Transient Thermal Response Curve.

Thermal characterization performed on the conditions described in Note 2. Transient thermal response will change depends on the circuit board design.



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